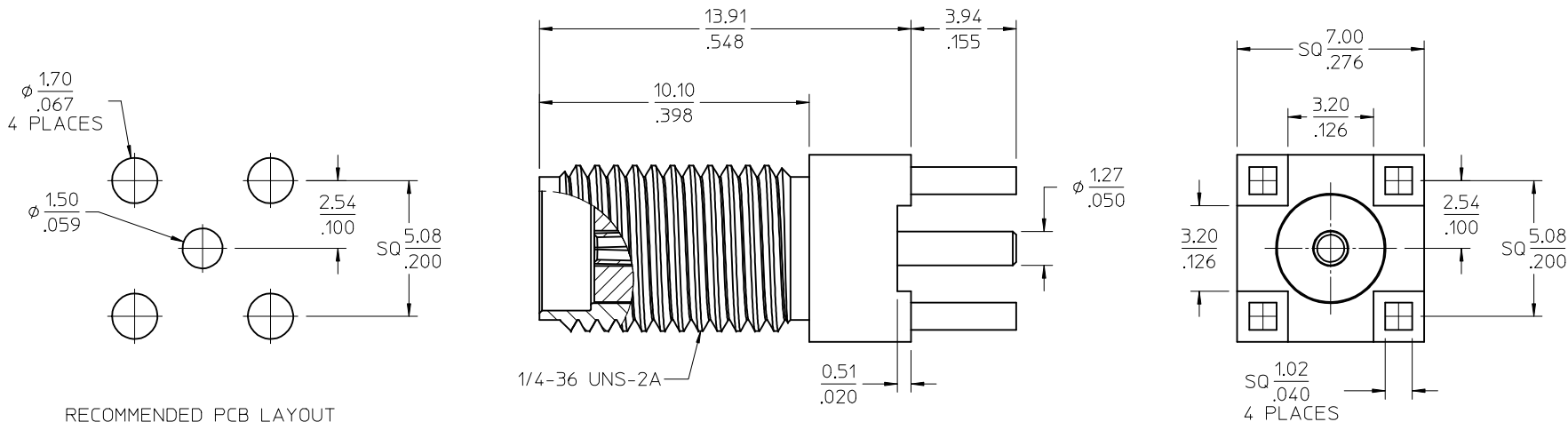
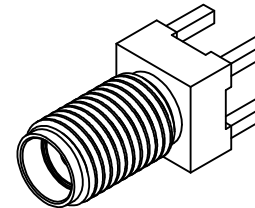


MATERIALS AND FINISHES:

BODY BRASS
 PLATED NICKEL

CONTACT BERYLLIUM COPPER
 PLATED GOLD

INSULATOR TEFLON



RECOMMENDED PCB LAYOUT

| | |
|--------------------------|-----------------------|
| 73251-6020 | TRAY |
| PART NO | PACKAGING |
| PS-89675-3460 | ELEC/MECH PERFORMANCE |
| MIL-STD-348A, FIG. 310.2 | INTERFACE |
| SPECIFICATION | DESCRIPTION |

| | | | | | | | | | | | | | | | | |
|--|------------|--|---------------------------|--------------------------------------|--|--|----------------------------------|--|---------------------------------------|--|---------------------------------------|--|---|--|---|--|
| A | 2013/02/05 | CHG:NEW RELEASE PER PDR13021267 EC NO: URF:2013-0509 DRW:RYEH CHKD: APPR:MHUANG | 2013/03/29 DESCRIPTION | QUALITY SYMBOLS ▽=0 ▽=0 ▽=0 | GENERAL TOLERANCES (UNLESS SPECIFIED) | | DIMENSION STYLE MM/IN | | SCALE 8:1 | | DESIGN UNITS METRIC | | THIRD ANGLE PROJECTION | | | |
| | | | | | 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- 0 PLACE ± --- ± --- | | DRAWN BY DATE RYEH 2013/02/05 | | CHECKED BY DATE VINCENT 2013/02/05 | | APPROVED BY DATE MHUANG 2013/03/29 | | TITLE SMA JACK STR PCB TH WITH SQ 7.0 BODY SMA-J/PCB molex | | | |
| DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS | | | | | | | MATERIAL NO. SEE TABLE | | DOCUMENT NO. SD-73251-602 | | SHEET NO. 1 OF 1 | | SIZE C | | THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION | |